



[Dynamic Series](#) | [Dynamic 3000 Series](#)

TE Internal #: 178306-2

PCB Mount Header, Horizontal, Wire-to-Board, 12 Position, 3.81 mm [.15 in] Centerline, Fully Shrouded, Gold, Dynamic 3000 Series

[View on TE.com >](#)

Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated



EU RoHS Compliance: **Compliant**

EU ELV Compliance: **Compliant**

PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Horizontal**

Connector System: **Wire-to-Board**

[All Header Assembly: Wire-to-Board, 15A, gold or tin plated \(120\)](#)

## Features

### Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

### Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

### Configuration Features

PCB Mount Orientation	Horizontal
Number of Positions	12
Number of Rows	2

### Electrical Characteristics



Operating Voltage	250 VDC
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### Body Features

Primary Product Color	Black
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### Contact Features

Contact Shape & Form	Rectangular
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Contact Underplating Material	Nickel
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Contact Layout	Matrix
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Contact Base Material	Copper Alloy
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PCB Contact Termination Area Plating Material	Tin
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Contact Mating Area Plating Material Thickness	.38 $\mu\text{m}$ [15 $\mu\text{in}$ ]
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Contact Mating Area Plating Material	Gold
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Contact Type	Tab
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Contact Current Rating (Max)	15 A
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### Termination Features

Termination Post & Tail Length	3.8 mm[.149 in]
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Termination Method to PCB	Through Hole - Solder
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### Mechanical Attachment

Mating Retention	With
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PCB Mount Retention Type	Retention Leg
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Mating Alignment Type	Keyed
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PCB Mount Retention	With
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PCB Mount Alignment	Without
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Connector Mounting Type	Board Mount
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Mating Alignment	With
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### Housing Features

Housing Material	Polyester GF
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Centerline (Pitch)	3.81 mm[.15 in]
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### Dimensions

Row-to-Row Spacing	5.08 mm[.2 in]
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### Usage Conditions

Operating Temperature Range	-55 – 105 $^{\circ}\text{C}$ [-67 – 221 $^{\circ}\text{F}$ ]
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### Operation/Application



Circuit Application	Power & Signal
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### Industry Standards

UL Flammability Rating	UL 94V-0
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### Packaging Features

Packaging Method	Tube, Box
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## Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

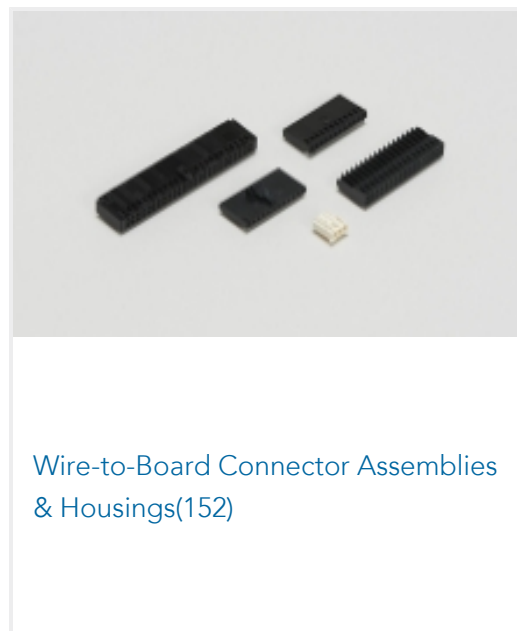
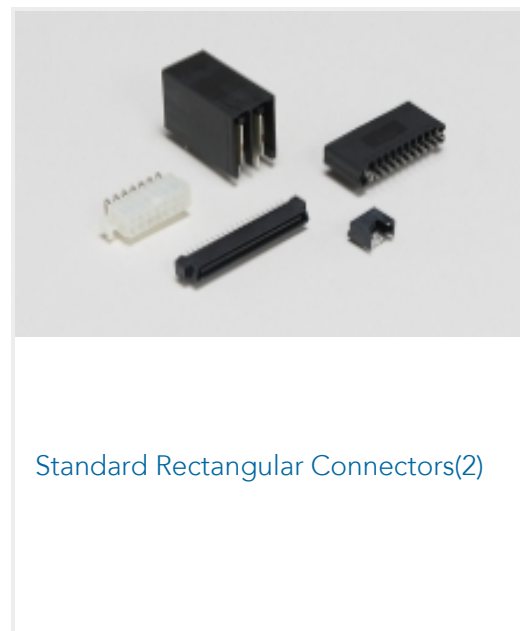
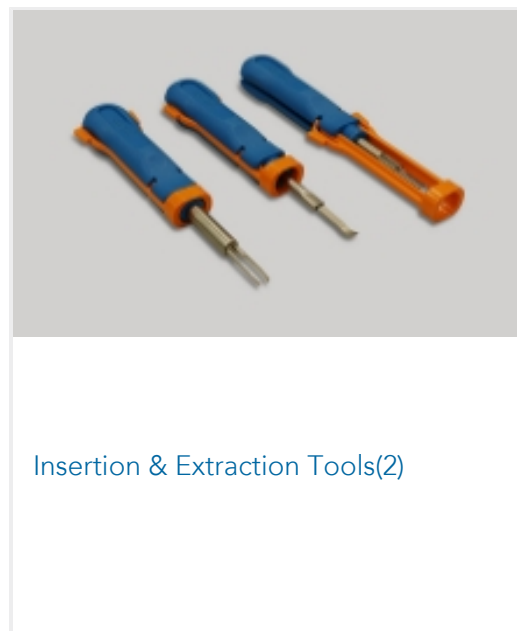
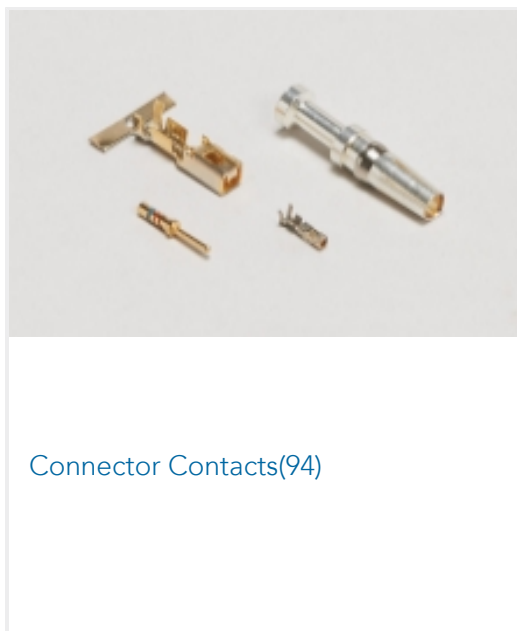
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



### Also in the Series | Dynamic 3000 Series



### Customers Also Bought





## Documents

### Product Drawings

[DYNAMIC D3100 HDR ASSY 12P H](#)

Japanese

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### CAD Files

[3D PDF](#)

English

Customer View Model

[ENG\\_CVM\\_178306-2\\_B1.2d\\_dxf.zip](#)

English

Customer View Model

[ENG\\_CVM\\_178306-2\\_B1.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_178306-2\\_B1.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

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### Product Specifications

[Product Specification](#)

English

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### Agency Approvals

[TUV Certificate](#)

English